

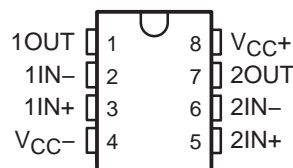
RC4558

DUAL GENERAL-PURPOSE OPERATIONAL AMPLIFIER

SLOS073D – MARCH 1976 – REVISED SEPTEMBER 2004

- **Continuous Short-Circuit Protection**
- **Wide Common-Mode and Differential Voltage Ranges**
- **No Frequency Compensation Required**
- **Low Power Consumption**
- **No Latch-Up**
- **Unity-Gain Bandwidth . . . 3 MHz Typ**
- **Gain and Phase Match Between Amplifiers**
- **Low Noise . . . 8 nV/√Hz Typ at 1 kHz**

D, DGK, P, PS, OR PW PACKAGE
(TOP VIEW)



description/ordering information

The RC4558 device is a dual general-purpose operational amplifier, with each half electrically similar to the μ A741, except that offset null capability is not provided.

The high common-mode input voltage range and the absence of latch-up make this amplifier ideal for voltage-follower applications. The device is short-circuit protected, and the internal frequency compensation ensures stability without external components.

ORDERING INFORMATION

T _A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	MSOP/VSSOP (DGK)	Reel of 2500	RC4558DGKR	YR_‡
	PDIP (P)	Tube of 50	RC4558P	RC4558P
	SOIC (D)	Tube of 75	RC4558D	RC4558
		Reel of 2500	RC4558DR	
	SOP (PS)	Reel of 2000	RC4558PSR	R4558
	TSSOP (PW)	Tube of 150	RC4558PW	R4558
Reel of 2000		RC4558PWR		
–40°C to 85°C	MSOP/VSSOP (DGK)	Reel of 2500	RC4558IDGKR	YS_‡
	PDIP (P)	Tube of 50	RC4558IP	RC4558IP
	SOIC (D)	Tube of 75	RC4558ID	R4558I
		Reel of 2500	RC4558IDR	
	TSSOP (PW)	Tube of 150	RC4558IPW	R4558I
		Reel of 2000	RC4558IPWR	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

‡ The actual top-side marking has one additional character that designates the assembly/test site.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

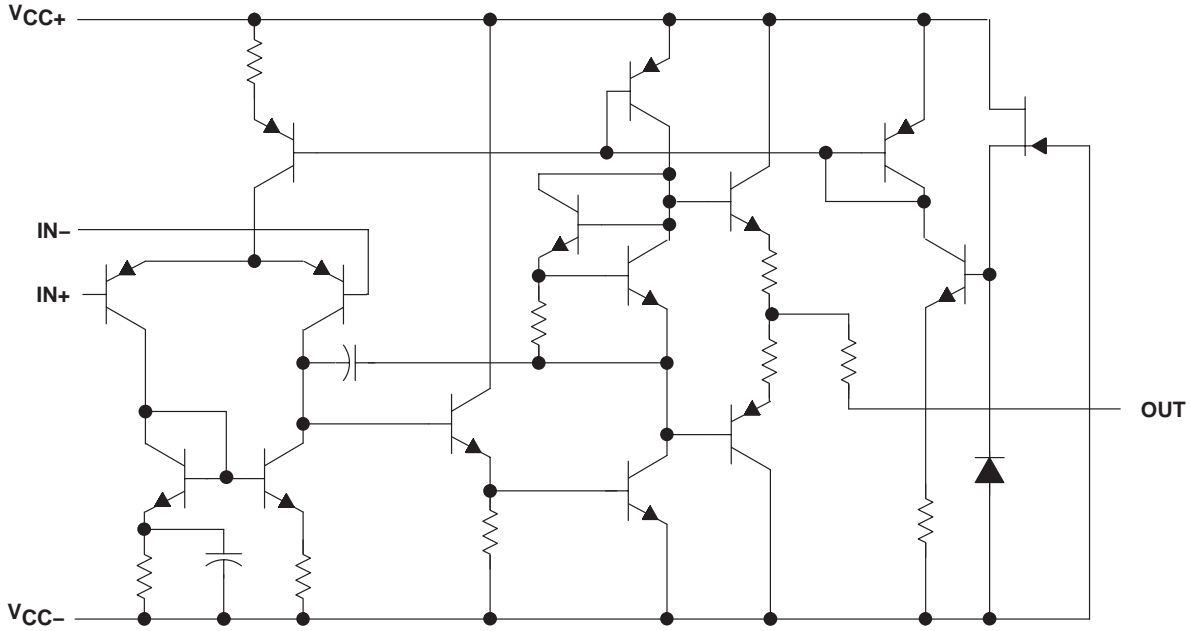
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2004, Texas Instruments Incorporated

RC4558 DUAL GENERAL-PURPOSE OPERATIONAL AMPLIFIER

SLOS073D – MARCH 1976 – REVISED SEPTEMBER 2004

schematic (each amplifier)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage (see Note 1): V_{CC+}	18 V
V_{CC-}	-18 V
Differential input voltage, V_{ID} (see Note 2)	± 30 V
Input voltage, V_I (any input, see Notes 1 and 3)	± 15 V
Duration of output short circuit to ground, one amplifier at a time (see Note 4)	Unlimited
Package thermal impedance, θ_{JA} (see Notes 5 and 6):	D package 97°C/W
	DGK package 172°C/W
	P package 85°C/W
	PS package 95°C/W
	PW package 149°C/W
Operating virtual junction temperature, T_J	150°C
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values, unless otherwise noted, are with respect to the midpoint between V_{CC+} and V_{CC-} .
 2. Differential voltages are at $IN+$ with respect to $IN-$.
 3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 V, whichever is less.
 4. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.
 5. Maximum power dissipation is a function of $T_J(\max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 6. The package thermal impedance is calculated in accordance with JESD 51-7.

RC4558 DUAL GENERAL-PURPOSE OPERATIONAL AMPLIFIER

SLOS073D – MARCH 1976 – REVISED SEPTEMBER 2004

recommended operating conditions

		MIN	MAX	UNIT	
V _{CC+}	Supply voltage	5	15	V	
V _{CC-}		-5	-15		
T _A	Operating free-air temperature	RC4558	0	70	°C
		RC4558I	-40	85	

electrical characteristics at specified free-air temperature, V_{CC+} = 15 V, V_{CC-} = -15 V

PARAMETER		TEST CONDITIONS†	MIN	TYP	MAX	UNIT	
V _{IO}	Input offset voltage	V _O = 0	25°C	0.5	6	mV	
			Full range		7.5		
I _{IO}	Input offset current	V _O = 0	25°C	5	200	nA	
			Full range		300		
I _{IB}	Input bias current	V _O = 0	25°C	150	500	nA	
			Full range		800		
V _{ICR}	Common-mode input voltage range	25°C	±12	±14		V	
V _{OM}	Maximum output voltage swing	R _L = 10 kΩ	25°C	±12	±14	V	
		R _L = 2 kΩ	25°C	±10	±13		
			Full range		±10		
A _{VD}	Large-signal differential voltage amplification	R _L ≥ 2 kΩ, V _O = ±10 V	25°C	20	300	V/mV	
			Full range		15		
B ₁	Unity-gain bandwidth	25°C		3		MHz	
r _i	Input resistance	25°C	0.3	5		MΩ	
CMRR	Common-mode rejection ratio	25°C	70	90		dB	
k _{SVS}	Supply-voltage sensitivity (ΔV _{IO} /ΔV _{CC})	V _{CC} = ±15 V to ±9 V	25°C	30	150	μV/V	
V _n	Equivalent input noise voltage (closed loop)	A _{VD} = 100, R _S = 100 Ω, f = 1 kHz, BW = 1 Hz	25°C	8		nV/√Hz	
I _{CC}	Supply current (both amplifiers)	V _O = 0, No load	25°C	2.5	5.6	mA	
			T _A (min)		3		6.6
			T _A (max)		2.3		5
P _D	Total power dissipation (both amplifiers)	V _O = 0, No load	25°C	75	170	mW	
			T _A (min)		90		200
			T _A (max)		70		150
V _{O1} /V _{O2}	Crosstalk attenuation	Open loop	R _S = 1 kΩ, f = 10 kHz	25°C	85	dB	
		A _{VD} = 100			105		

† All characteristics are measured under open-loop conditions with zero common-mode input voltage, unless otherwise specified. Full range is 0°C to 70°C for RC4558 and -40°C to 85°C for RC4558I.

operating characteristics, V_{CC+} = 15 V, V_{CC-} = -15 V, T_A = 25°C

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
t _r	Rise time	V _I = 20 mV,	R _L = 2 kΩ,	C _L = 100 pF		0.13	ns
	Overshoot	V _I = 20 mV,	R _L = 2 kΩ,	C _L = 100 pF		5	%
SR	Slew rate at unity gain	V _I = 10 V,	R _L = 2 kΩ,	C _L = 100 pF	1.1	1.7	V/μs



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
RC4558D	ACTIVE	SOIC	D	8	75	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
RC4558DGKR	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1YEAR
RC4558DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
RC4558ID	ACTIVE	SOIC	D	8	75	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
RC4558IDGKR	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1YEAR
RC4558IDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
RC4558IP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
RC4558IPW	ACTIVE	TSSOP	PW	8	150	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
RC4558IPWR	ACTIVE	TSSOP	PW	8	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
RC4558P	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
RC4558PSLE	OBSOLETE	SO	PS	8		None	Call TI	Call TI
RC4558PSR	ACTIVE	SO	PS	8	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
RC4558PW	ACTIVE	TSSOP	PW	8	150	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
RC4558PWLE	OBSOLETE	TSSOP	PW	8		None	Call TI	Call TI
RC4558PWR	ACTIVE	TSSOP	PW	8	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
RC4558Y	OBSOLETE	XCEPT	Y	0		None	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the

accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE

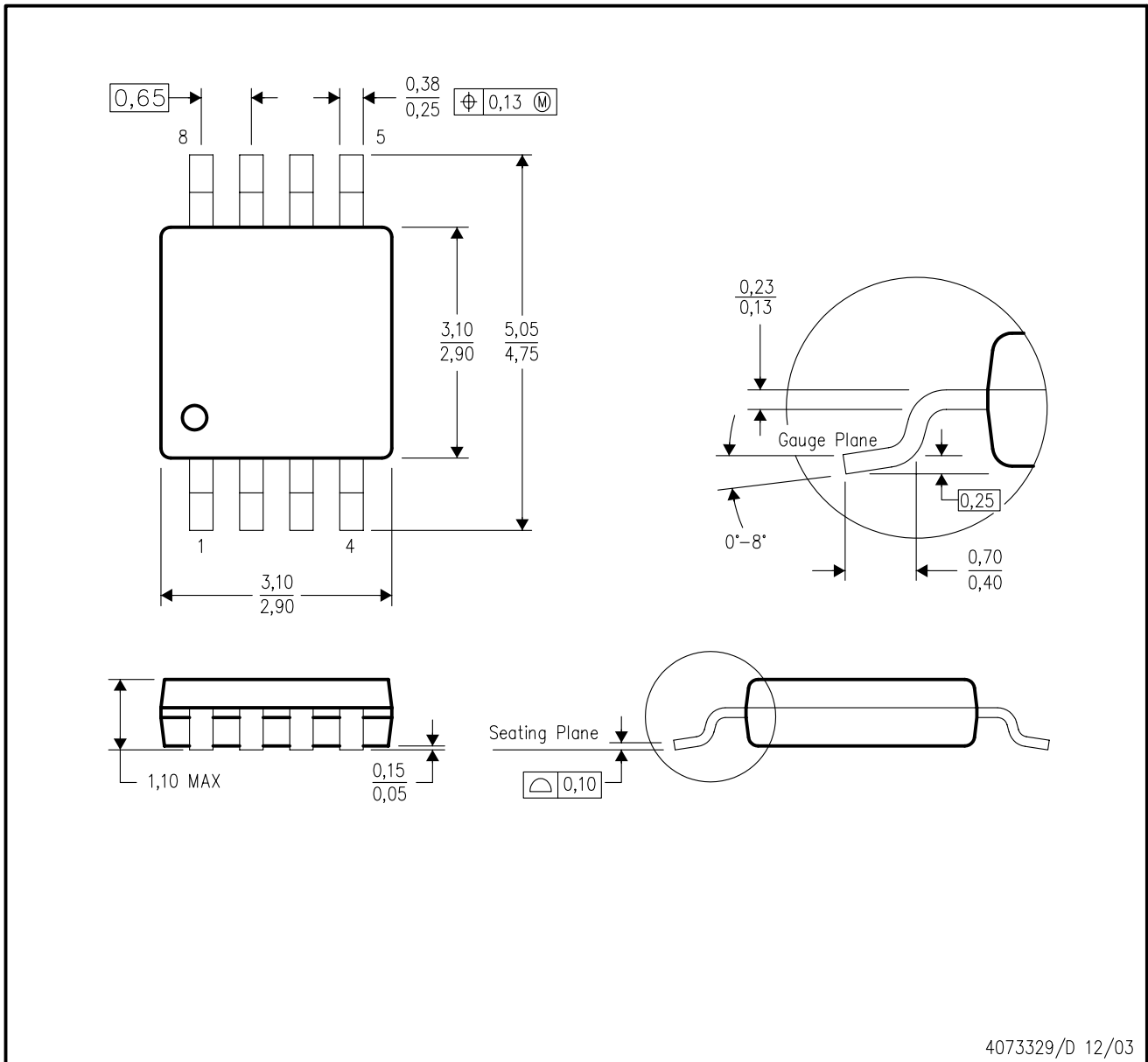


- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm

DGK (S-PDSO-G8)

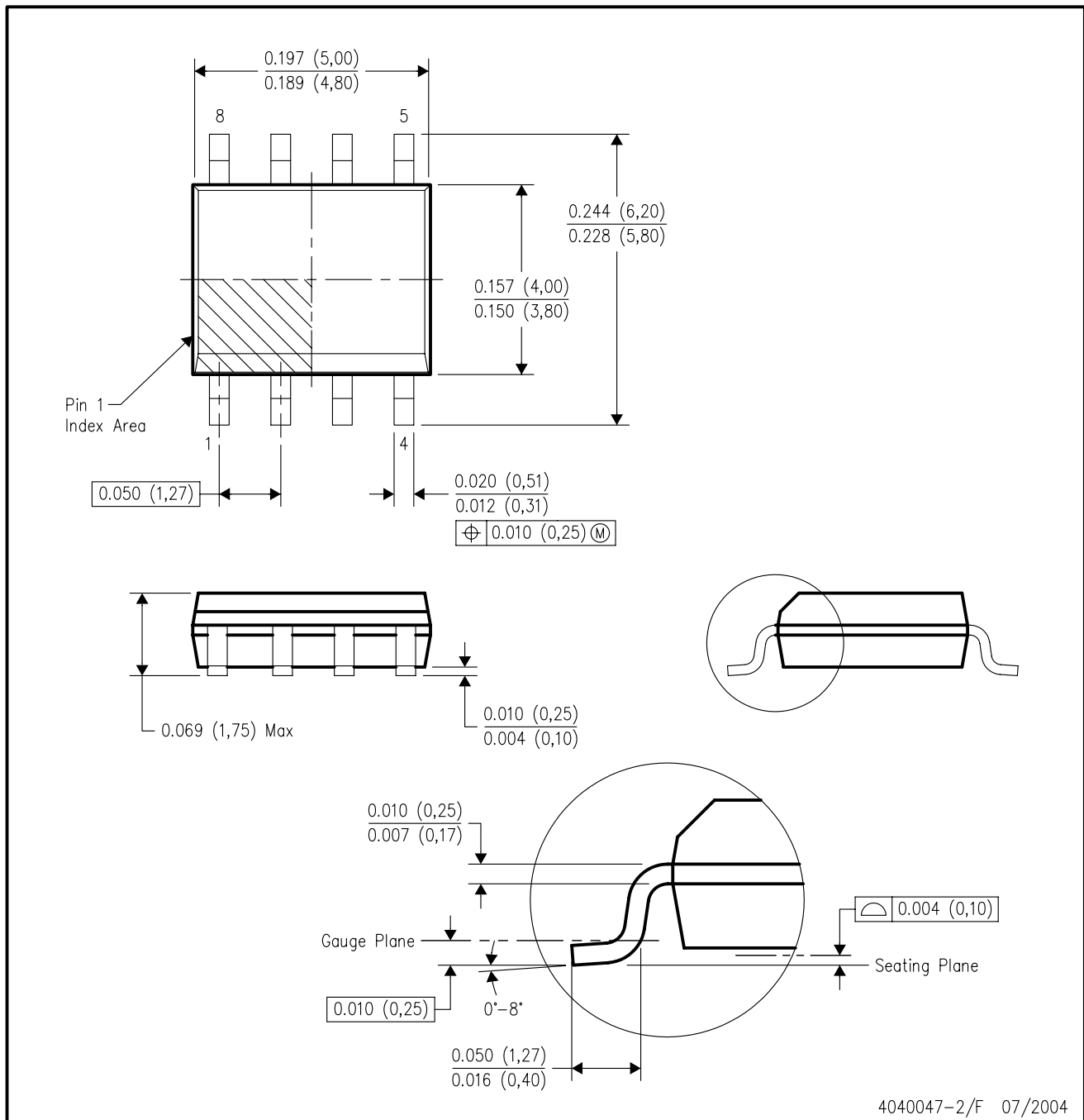
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion.
 - D. Falls within JEDEC MO-187 variation AA.

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-012 variation AA.

MECHANICAL DATA

PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265